

Listing of the Claims:

1. (Amended) A high density audio/video input/output interconnection device comprising:

a high density connector block that includes a plurality of jacks disposed on an outer surface of the high density connector block including, a S-video input jack, a S-video output jack, a composite video input jack, a composite video output jack, a digital audio output jack, a right channel audio input jack and a left channel audio input jack;

~~[the plurality of input jacks disposed on a first side surface and the plurality of output jacks disposed on a second side surface;]~~

a high density connector that interfaces with a computer commonly interconnected to the plurality of jacks via a first cable; and,

a plug for stereo audio output ~~[inter]~~connected to the high density connector ~~[for interface with a computer]~~ via a second cable.

2. (Original) The connector as recited in claim 1, wherein the plurality of jacks further include a digital video input/output jack.

3. (Original) The connector as recited in claim 1, wherein the high density connector block further includes a jack for interconnection with an infrared transceiver.

4. (Original) The connector as recited in claim 1, wherein the plurality of input jacks are disposed on opposing side from the plurality of output jacks.

5. (Original) The connector as recited in claim 1, wherein the high density connector block further includes an infrared transceiver disposed on a surface of the high density connector block separate from a first side surface of the plurality of input jacks and the second side surface of the plurality of output jacks.

6. (Amended) The connector as recited in claim 1, wherein the plurality of input jacks are disposed on a first side surface and the plurality of output jacks are disposed on a second side surface, such that the first side surface includes a multi-faceted recessed portion and the second

side surface includes a multi-faceted projecting portion, wherein the recessed portion and corresponding projecting portion are defined by a plurality of surface elements.

7. (Amended) A high density audio/video input/output connector block, comprising:

a housing having a longitudinal axis and including a top surface, a bottom surface, a front surface, a back surface, a first side surface, and a second side surface, such that the first and second side surfaces are oppositely disposed;

a plurality of ~~[input]~~ jacks, for interconnection with peripheral devices, disposed on the first ~~[side surface]~~ and ~~[a plurality of output jacks, for interconnection with peripheral devices, disposed on the]~~ second side surfaces;

a recessed portion formed on the first side surface having at least one of the plurality of ~~[input]~~ jacks disposed therein;

a projecting portion formed on the second side surface having at least one of the plurality ~~[output]~~ of jacks disposed therein; and,

a cable associated with the back surface.

8. (Amended) The connector as recited in claim 7, wherein the plurality of ~~[input]~~ jacks disposed on the first side surface includes at least one jack selected from the group consisting of a S-video input jack, a composite video input jack, an audio right channel input jack, an audio left channel input jack.

9. (Amended) The connector as recited in claim 7, wherein the plurality of ~~[output]~~ jacks disposed on the second side surface includes at least one jack selected from the group consisting of a digital video input/output jack, a S-video output jack, a composite video output, and a digital audio output jack.

10. (Original) The connector as recited in claim 7, wherein the high density connector block further includes an infrared transceiver associated therewith.

11. (Original) The connector as recited in claim 10, wherein the infrared transceiver is disposed on the front surface.

12. (Original) The connector as recited in claim 7, wherein the top surface further includes a grip enhancing portion defined by a plurality of ribs for increasing an operator's ability to grip the high density connector block.

13. (Original) The connector as recited in claim 7, wherein the cable is disposed offset from the longitudinal axis.

14. (Original) The connector as recited in claim 7, wherein the recessed portion includes a first surface element offset from the first side surface such that the first side surface is disposed at a first distance from the longitudinal axis which is greater than a second distance associated with the offset first surface element.

15. (Original) The connector as recited in claim 7, wherein the projecting portion includes a second side surface element offset from the second side surface such that the second side surface is disposed at a fourth distance from the longitudinal axis which is less than a fifth distance associated with the offset second side surface element.

16. (Original) The connector as recited in claim 7, wherein the recessed and projecting portions each further include at least one surface element which is parallel to the first and second side surfaces.

17. (Original) The connector as recited in claim 7, wherein the recessed portion includes a first multi-faceted surface having a plurality of first surface elements angularly disposed to one another.

18. (Original) The connector as recited in claim 7, wherein the projecting portion includes a second multi-faceted surface having a plurality of second surface elements angularly disposed to one another.

19. (Amended) A high density audio/video input/output connector block, comprising:

a housing including a first side surface and a second side surface, and having a longitudinal axis;

at least one audio ~~[input]~~ jack disposed on the first ~~[side surface]~~ and ~~[at least one audio output jack disposed on the]~~ second side surfaces ~~[, both]~~ defined in a first plane; and,

at least one video ~~input~~ jack disposed on the first ~~[side surface]~~ and ~~[at least one video output jack disposed on the]~~ second side surfaces ~~[, both]~~ defined in a second plane, where that the first and second planes are substantially parallel such that the audio and video jacks are offset.

20. (Original) The connector as recited in claim 19, wherein the first side surface further includes a recessed portion.

21. (Original) The connector as recited in claim 20, wherein at least one video jack disposed on the first side surface is disposed within the recessed portion.

22. (Original) The connector as recited in claim 19, wherein the second side surface further includes a projecting portion.

23. (Original) The connector as recited in claim 22, wherein at least one video jack disposed on the second side surface is disposed within the projecting portion.

24. (Original) The connector as recited in claim 19, wherein the housing further includes an infrared transceiver associated therewith.

25. (Original) The connector as recited in claim 24, wherein the infrared transceiver is disposed on a surface separate from the audio and video jacks.

26. (Original) A high density audio/video input/output interconnection device, comprising:

a high density connector for engagement with a computer connected to a first end of a first cable and a first end of a second cable;

a high density connector block connected to a second end of the first cable for interconnection with peripheral devices and in common communication with the high density connector;

the high density connector block including a top surface, a bottom surface, a front surface, a back surface, a first side surface, and a second side surface, such that the first and second side surfaces are oppositely disposed;

a recessed portion formed on the first side surface where a first plurality of jacks are disposed on the first side surface including within the recessed portion for interconnection with peripheral devices;

a projecting portion forward on the second side surface where a second plurality of jacks are disposed on the second side surface including within the projecting portion for interconnection with peripheral devices;

the first plurality of jacks disposed on the first side selected from the group consisting of a S-video input jack, a composite video input jack; an audio right channel input jack, an audio left channel input jack, and an infrared transceiver jack;

the second plurality of jacks disposed on the second side are selected from the group consisting of a digital input/output jack, a S-video output jack, a composite video output jack, and a digital audio output jack; and,

a multi-channel audio plug connected to a second end of the second cable.

27. (Original) The connector as recited in claim 26, wherein the top surface further includes a grip enhancing portion defined by a plurality of ribs formed in the top surface.

28. (Original) The connector as recited in claim 26, wherein the audio jacks on the first and second side surfaces are defined in a first plane and the video jacks disposed on the first and second side surfaces are defined in a second plane where the first and second planes are offset substantially parallel such that the audio and video jacks are offset.

29. (Amended) A high density audio/video input/output interconnection device comprising:

a high density connector block that includes a plurality of jacks disposed on an outer surface of the high density connector block including, a S-video input jack, a S-video output jack, a video input jack, a video output jack, at least one audio output jack and at least one audio input jack;

~~[the plurality of input jacks disposed on a first side surface and the plurality of output jacks disposed on a second side surface;]~~

a high density connector that interfaces with a computer commonly interconnected to the plurality of jacks via a first cable; and,

a plug for stereo audio output ~~[inter]~~connected to the high density connector ~~[for interface with a computer]~~ via a second cable.

30. (Previously Presented) The connector as recited in claim 29, wherein the plurality of jacks further include a digital video input/output jack.

31. (Previously Presented) The connector as recited in claim 29, wherein the high density connector block further includes a jack for interconnection with an infrared transceiver.

32. (Previously Presented) The connector as recited in claim 29, wherein the plurality of input jacks are disposed on opposing side from the plurality of output jacks.

33. (Previously Presented) The connector as recited in claim 29, wherein the high density connector block further includes an infrared transceiver disposed on a surface of the high density connector block separate from a first side surface of the plurality of input jacks and the second side surface of the plurality of output jacks.

34. (Amended) The connector as recited in claim 29, wherein the plurality of input jacks are disposed on a first side surface and the plurality of output jacks are disposed on a second side surface, such that the first side surface includes a multi-faceted recessed portion and the second

side surface includes a multi-faceted projecting portion, wherein the recessed portion and corresponding projecting portion are defined by a plurality of surface elements.